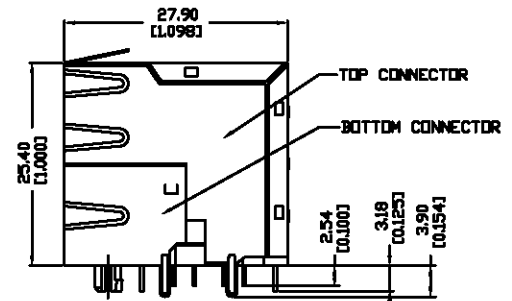
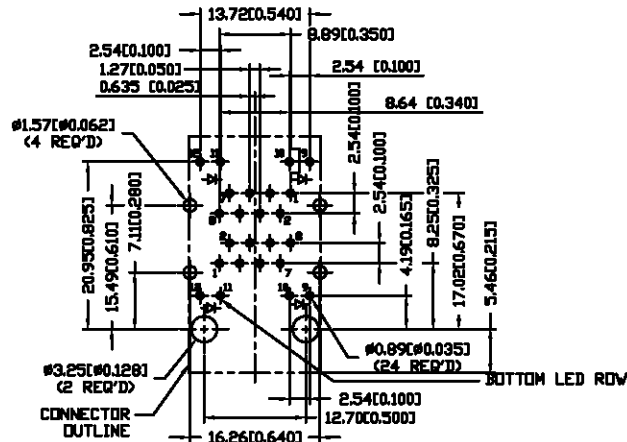


FRONT VIEW



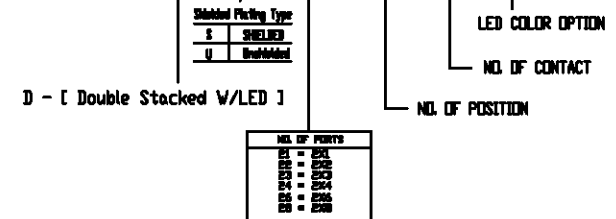
SIDE VIEW



SUGGESTED PCB LAYOUT
TOP VIEW

XMULTIPLE PART NUMBER

XRJD-S-21-8-8-X



NOTES:

- MATERIALS:**
HOUSING: HIGH TEMP. THERMOPLASTIC, BLACK, UL 94V-0
CONTACTS: 0.014 INCHES (0.35 MILLIMETERS) THICK PHOSPHOR BRONZE PLATED WITH 150 MICROINCHES (3.81 MICROMETERS) MINIMUM THICK TIN LEAD IN SOLDER AREA. 15 MICROINCHES (0.38 MICROMETERS) MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE CONTACTS PLATED WITH 50 MICROINCHES (1.27 MICROMETERS) MINIMUM THICK NICKEL.
SHIELDED: 0.0098 INCHES (0.25 MILLIMETERS) THICK COPPER ZINC ALLOY PLATED WITH 30 MICROINCHES (0.762 MICROMETERS) MINIMUM THICK NICKEL
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F
- PART NUMBER: XRJD-S-21-8-8-X
REFER TO LED OPTIONS TABLE FOR ORDERING CODES
- UNSPECIFIED TOLERANCE: .XX ±0.25(0.010)
.X ±0.30(0.012)

		CONNECTING THE INFORMATION AGE	
		MULTIPLE USA 1402 Los Angeles Ave., Suite G, San Valley, CA 93065	
THIS DRAWING IS A CONTROLLED DOCUMENT.			
PART NO: XRJD-S-21-8-8-X		CUSTOMER/NO:	
TITLE: Stacked RJ45 Connectors, W/LED, 8P, 8C, Shielded, Thru Hole, 2 Piece Structure		DWG NO: XRJD-S-21-8-8-X	
DRAWN: LEON		CHECK: JEFF	
DATE: 12/04/05		REV: S01	
		DIMENSIONS	SHEET
mm [Inch]		1	1 of 1